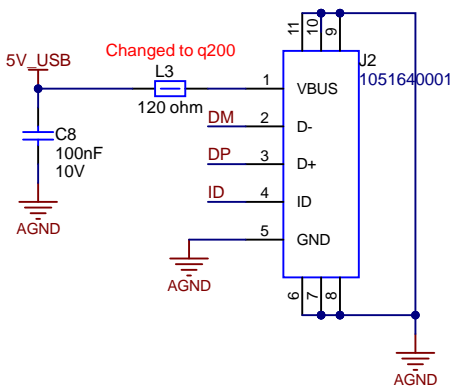
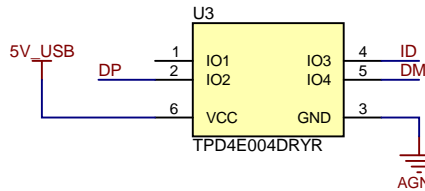


FTDI

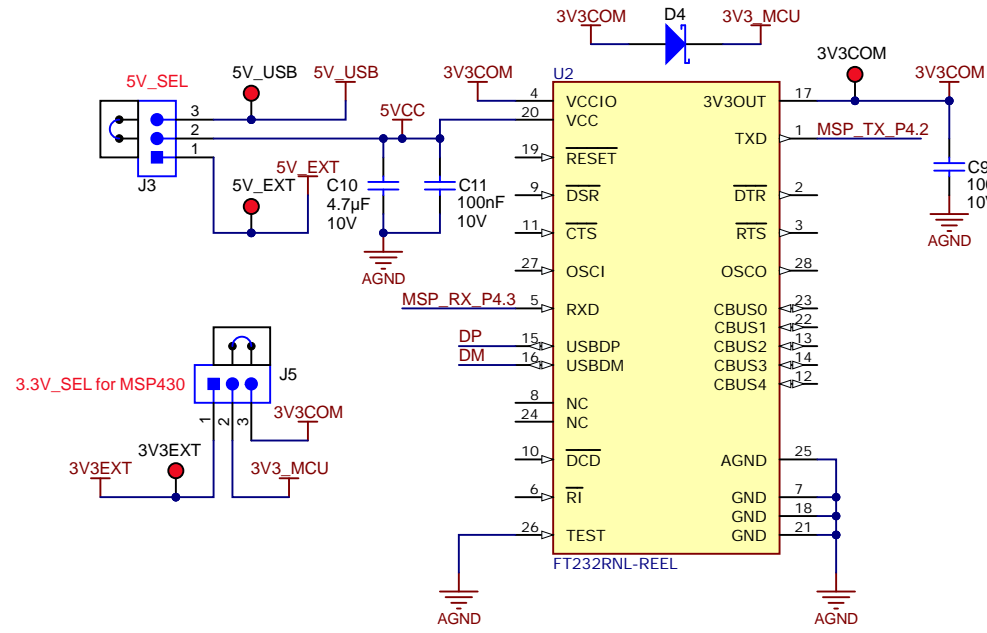
Micro USB Connector



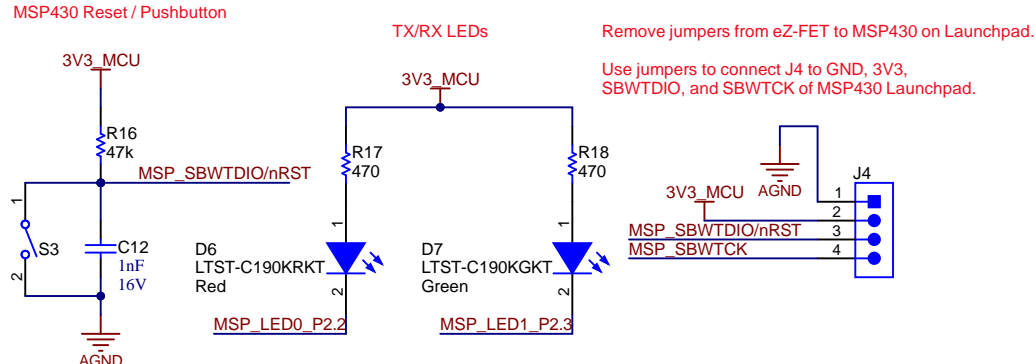
USB ESD Protection



FTDI REGULATOR



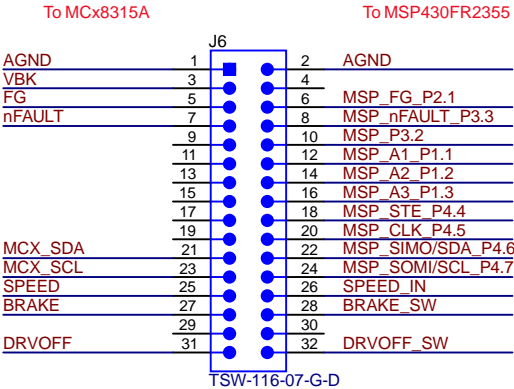
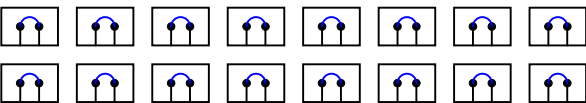
MCU PROGRAMMING



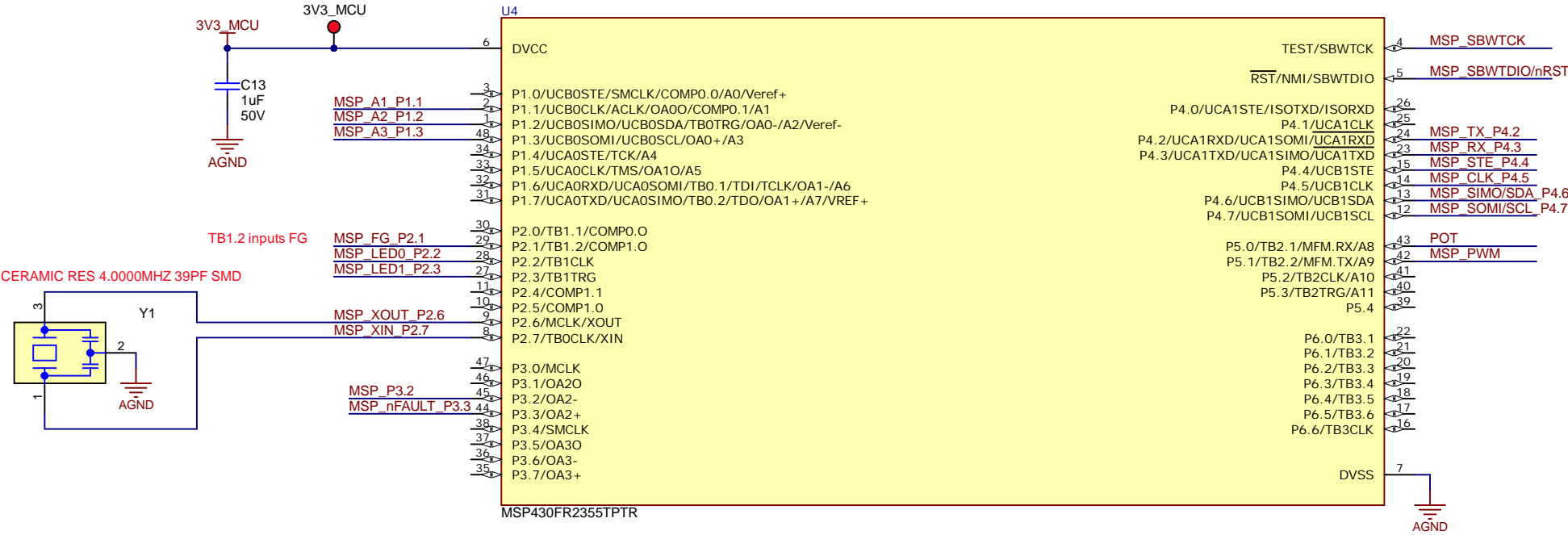
MSP430FR2355

MSP430FR2355

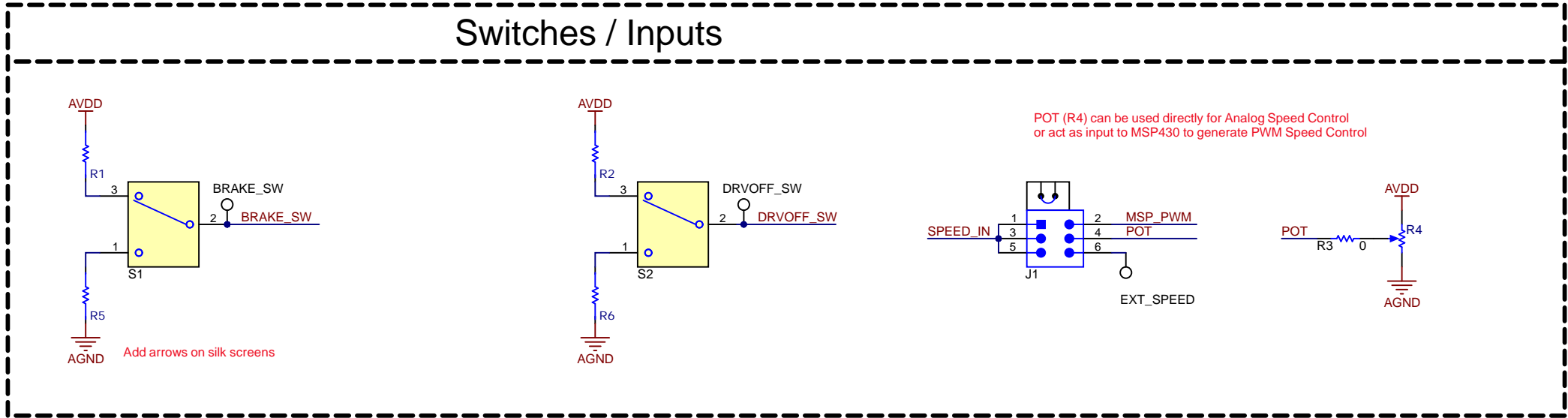
Signal Bank for connecting MSP430 + MCx8316A

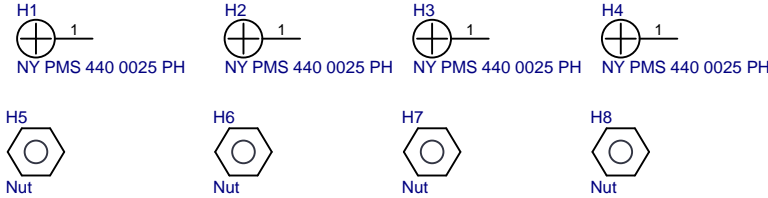


Populate jumpers to communicate onboard MSP430FR2355 to the MCx8315A or depopulate jumpers to use standalone MSP430 or MCx8315A.



Orderable: MCF8315PWPEVM	Designed for: Public Release	Mod. Date: 4/1/2024
TID #: N/A	Project Title: MCF8315PWPEVM	
Number: MD097A	Rev: Rev1.0	Sheet Title:
SVN Rev: 6d132efd4212892547b3783e0b5720a06d01	File: MD097_INTERFACE.SchDoc	Sheet: 1 of 5
Drawn By:	Size: B	
Engineer: Eric Chen	Contact: http://www.ti.com/support	





PCB Number: MD097A
PCB Rev: Rev1.0

PCB
LOGO
Texas Instruments



PCB
LOGO
FCC disclaimer

PCB
LOGO
WEEE logo

LBL1
PCB Label
THT-14-423-10



CAUTION HOT SURFACE



CAUTION HOT SURFACE

Variant/Label Table	
Variant	Label Text
001	MCF8315C1VPWPR

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.